

Docket No. 240346US0



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

IN RE APPLICATION OF: Seiji TAKEI, et al.

SERIAL NUMBER: 10/617,664

ATTN: APPLICATION BRANCH

FILING DATE: July 14, 2003

FOR: THERMOPLASTIC RESIN COMPOSITION AND PRODUCTION METHOD THEREOF

FILING OF DECLARATION UNDER 37 CFR 1.53(f)

COMMISSIONER FOR PATENTS
ALEXANDRIA, VIRGINIA 22313

SIR:

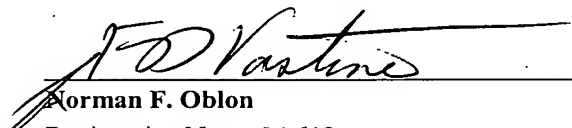
Responsive to the notification dated October 16, 2003, and in accordance with the provisions of 37 CFR 1.53(f), Applicants submit herewith a Rule 63 Declaration.

The required fee was paid at the time of filing the application.

In light of the foregoing, this application is deemed to be in proper condition for examination and such favorable action is earnestly solicited.

Respectfully Submitted,

OBLON, SPIVAK, McCLELLAND,
MAIER & NEUSTADT, P.C.


Norman F. Oblon
Registration No. 24,618

Customer Number

22850

Tel. (703) 413-3000
Fax. (703) 413-2220
(OSMMN 05/03)

Frederick D. Vastine
Registration No. 27,013

Declaration, Power Of Attorney and Petition



Page 1 of 3

WE (I) the undersigned inventor(s), hereby declare(s) that:

My residence, post office address and citizenship are as stated below next to my name,

We (I) believe that we are (I am) the original, first, and joint (sole) inventor(s) of the subject matter which is claimed and for which a patent is sought on the invention entitled

THERMOPLASTIC RESIN COMPOSITION AND PRODUCTION METHOD THEREOF

the specification of which

☐ is attached hereto.

☒ was filed on July 14, 2003 as
Application Serial No. 10/617,664
and amended on _____.

☐ was filed as PCT international application

Number _____

on _____,

and was amended under PCT Article 19

on _____ (if applicable).

We (I) hereby state that we (I) have reviewed and understand the contents of the above-identified specification, including the claims, as amended by any amendment referred to above.

We (I) acknowledge the duty to disclose information known to be material to the patentability of this application as defined in Section 1.56 of Title 37 Code of Federal Regulations.

We (I) hereby claim foreign priority benefits under 35 U.S.C. § 119(a)-(d) or § 365(b) of any foreign application(s) for patent or inventor's certificate, or § 365(a) of any PCT International application which designated at least one country other than the United States, listed below and have also identified below, by checking the box, any foreign application for patent or inventor's certificate, or PCT International application having a filing date before that of the application on which priority is claimed. Prior Foreign Application(s)

Application No.	Country	Day/Month/Year	Priority Claimed	
P2001-057177	Japan	01/03/2001	<input type="checkbox"/> Yes	<input checked="" type="checkbox"/> No
P2001-316092	Japan	12/10/2001	<input type="checkbox"/> Yes	<input checked="" type="checkbox"/> No
_____	_____	_____	<input type="checkbox"/> Yes	<input type="checkbox"/> No
_____	_____	_____	<input type="checkbox"/> Yes	<input type="checkbox"/> No

We (I) hereby claim the benefit under Title 35, United States Code, § 119(e) of any United States provisional application(s) listed below.

_____ (Application Number)	_____ (Filing Date)
_____ (Application Number)	_____ (Filing Date)

We (I) hereby claim the benefit under 35 U.S.C. § 120 of any United States application(s), or under § 365(c) of any PCT International application designating the United States, listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States or PCT International in the manner provided by the first paragraph of 35 U.S.C. § 112, I acknowledge the duty to disclose information which is material to patentability as defined in 37 CFR § 1.56 which became available between the filing date of the prior application and the national or PCT International filing date of this application.

Application Serial No.	Filing Date	Status (pending, patented, abandoned)
_____	_____	_____
_____	_____	_____
_____	_____	_____

And we (I) hereby appoint the following registered practitioner(s):

**022850**

as our (my) attorneys, with full powers of substitution and revocation, to prosecute this application and to transact all business in the Patent Office connected therewith; and we (I) hereby request that all correspondence regarding this application be sent to

**022850**

We (I) declare that all statements made herein of our (my) own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issuing thereon.

Seiji Takei

NAME OF FIRST SOLE INVENTOR

Seiji Takei

Signature of Inventor

December 8, 2003

Date

Residence: Tokyo, Japan

Citizen of: Japan

Mailing Address: c/o Mitsubishi Rayon Co.,
Ltd., 6-41, Konan 1-chome, Minato-ku,

Tokyo, Japan

Masahiro Osuka

NAME OF SECOND JOINT INVENTOR

Masahiro Osuka

Signature of Inventor

December 8, 2003

Date

Hideo Aoki

NAME OF THIRD JOINT INVENTOR

Hideo Aoki

Signature of Inventor

December 8, 2003

Date

Mari Sekita

NAME OF FOURTH JOINT INVENTOR

Mari Sekita

Signature of Inventor

December 8, 2003

Date

Masaaki Mouri

NAME OF FIFTH JOINT INVENTOR

Masaaki Mouri

Signature of Inventor

December 8, 2003

Date

Residence: Hiroshima-shi, JapanCitizen of: JapanPost Office Address: c/o Mitsubishi Rayon
Co., Ltd., Otake Pants, 20-1, Miyuki-cho,
Otake-shi, Hiroshima-ken, JapanResidence: Sagamihara-shi, JapanCitizen of: JapanPost Office Address: c/o Mitsubishi Rayon
Co., Ltd., Tokyo Technology and Information
Center, 3816, Noborito, Tama-ku,
Kawasaki-shi, Kanagawa-ken, JapanResidence: Tokyo, JapanCitizen of: JapanPost Office Address: c/o Mitsubishi Rayon Co.,
Ltd., Tokyo Technology and Information
Center, 3816, Noborito, Tama-ku,
Kawasaki-shi, Kanagawa-ken, JapanResidence: Kawasaki-shi, JapanCitizen of: JapanPost Office Address: c/o Mitsubishi Rayon Co.,
Ltd., 6-41, Konan 1-chome, Minato-ku,
Tokyo, Japan